Amendments to the Claims:

The following listing of claims will replace all prior versions, and listings, of claims in the application:

- 1-17. (Canceled)
- 18. (Previously Presented) An on-chip optical interconnection circuit, comprising:
 a first circuit block provided on an integrated circuit chip;
 - a second circuit block provided on the integrated circuit chip;
- a first element having a light emitting function provided on the first circuit

block;

a second element having a light receiving function provided on the second circuit block; and

an optical waveguide being provided on the integrated circuit chip,

the first circuit block being connected to the second circuit block through the optical waveguide, and

the optical waveguide being in contact with the first element and with the second element.

19. (Previously Presented) The on-chip optical interconnection circuit according to claim 18,

the first circuit block and the second circuit block being electrically connected to each other.

20. (Currently Amended) The on-chip optically interconnection circuit according to claim 18,

the first element electrically connected to the first circuit block and optically connected to the optical waveguide,

the second element electrically connected to the second circuit block and optically connected to the optical waveguide.

21. (Currently Amended) The on-chip optically interconnection circuit according to claim 18,

at least a portion of the optical waveguide covering the first element and the second element.

22. (Currently Amended) The on-chip optically interconnection circuit according to claim 18,

at least a portion of the optical waveguide being provided on a top surface of the first circuit block and on a top surface of the second circuit block.

23. (Currently Amended) The on-chip optically interconnection circuit according to claim 18,

at least a portion of the optical waveguide crossing at least one of the first circuit <u>block</u> and the second circuit <u>block</u>.

24. (Currently Amended) The on-chip optically interconnection circuit according to claim 18,

at least a portion of the optical waveguide being provided to bypass the first circuit <u>block</u> and the second circuit <u>block</u>.

25. (Currently Amended) The on-chip optically interconnection circuit according to claim 18,

the first circuit block and the second circuit block being one of a CPU, a memory circuit, a DSP, a RF amplification circuit, an image sensor, and a biosensor.

26. (Previously Presented) The on-chip optical interconnection circuit according to claim 18,

the optical waveguide being a transmission line for data signals or clock signals.

27. (Currently Amended) An on-chip optical interconnection circuit, comprising:
a plurality of circuit blocks provided on an integrated circuit chip;
a plurality of optical waveguides; and
a plurality of elements having a light emitting function or a light receiving
function;

at least two of the plurality of circuit blocks being optically connected to each other through at least one of the plurality of optical waveguides,

at least one of the plurality of elements electrically connected to at least one of the plurality of circuit blocks and optically connected to at least one of the plurality of optical waveguides;

two or more elements of the plurality of elements provided on one of the plurality of circuit blocks, and

at least one of the plurality of optical waveguides being provided for each of the two or more elements.

28. (Currently Amended) An on-chip optical interconnection circuit, comprising: a substrate;

a plurality of integrated circuit chips being mounted on the substrate;

a plurality of optical waveguides;

a plurality of circuit blocks at least one circuit block provided on each of the plurality of integrated circuit chips; and

a plurality of elements at least one element having a light emitting function or a light receiving function being provided on each of the plurality of circuit blocks block;

the plurality of at least one circuit blocks being optically connected to each other another at least one circuit block through at least one of the plurality of optical waveguides, and

the plurality of integrated circuit chips being optically connected to each other through at least one of the plurality of elements element, and at least one of the plurality of optical waveguides.

29. (Currently Amended) The on-chip optical interconnection circuit according to claim 28,

the integrated circuit chip and the plurality of integrated circuit chips being mounted on the substrate,

the plurality of integrated circuit chips being mounted close to each other, and

at least one of the plurality of integrated circuit chips being electrically

connected to each other another one of the plurality of integrated circuit chips.

30. (Currently Amended) The on-chip optical interconnection circuit according to claim 18,

the optical waveguide including a light scattering frame scattering a light; emitted by the first elements.

31. (Currently Amended) The on-chip optical interconnection circuit according to claim 18,

the optical waveguide including a light reflecting frame reflecting a light, emitted by the first elements.

- 32. (Previously Presented) An electro-optical device, comprising: the on-chip optical interconnection circuit according to claim 18.
- 33. (Previously Presented) An electronic apparatus, comprising:
 the on-chip optical interconnection circuit according to claim 18.

- 34. (New) The on-chip optical interconnection circuit according to claim 19,
 the first circuit block and the second circuit block being electrically connected
 to each other through at least one metal wiring line.
 - 35. (New) An optical interconnection circuit, comprising:
 - a first circuit block;
 - a second circuit block;
- a first element having a light emitting function provided on the first circuit block;
- a second element having a light receiving function provided on the second circuit block; and

an optical waveguide to optically connect the first circuit block and the second circuit block to each other.

- 36. (New) The optical interconnection circuit according to claim 35,
 the first circuit block and the second circuit block being electrically connected
 to each other through at least one metal wiring line.
- 37. (New) The optical interconnection circuit according to claim 35,
 the first element being in contact with the optical waveguide and being
 provided between the first circuit block and the optical waveguide, and the second element
 being in contact with the optical waveguide and being provided between the second circuit
 block and the optical waveguide.
- 38. (New) The optical interconnection circuit according to claim 35,
 each of the first circuit block and the second circuit block being one of a CPU,
 a memory circuit, a DSP, a RF amplification circuit, an image sensor, and a biosensor.